

## N Channel Enhancement Mode Power MOSFET

### GENERAL DESCRIPTION

The JY11M utilizes the latest trench processing techniques to achieve the high cell density and reduces the on-resistance with high repetitive avalanche rating. These features combine to make this design an extremely efficient and reliable device for use in power switching application and a wide variety of other applications.

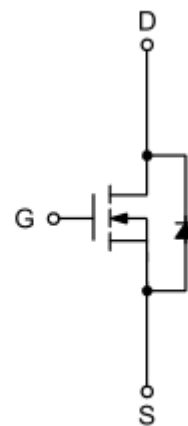
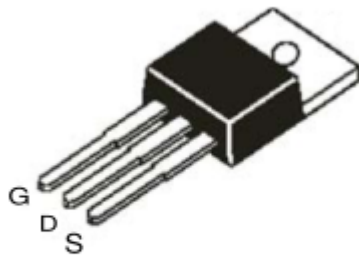
### FEATURES

- 100V/110A,  $R_{DS(ON)}=6.5m\Omega@V_{GS}=10V$
- Fast switching and reverse body recovery
- Fully characterized avalanche voltage and current
- Excellent package for good heat dissipation

### APPLICATIONS

- Switching application
- Hard switched and high frequency circuits
- Power Management for Inverter Systems

### PIN DESCRIPTION



N-Channel MOSFET

# JY11M

## Absolute Maximum Ratings(Tc=25° C Unless Otherwise Noted)

Symbol	Parameter	Limit	Unit	
V <sub>DS</sub>	Drain-Source Voltage	100	V	
V <sub>GS</sub>	Gate-Source Voltage	± 20	V	
I <sub>D</sub>	Continuous Drain Current	Tc=25° C	110	A
		Tc=100° C	82	
I <sub>DM</sub>	Pulsed Drain Current	395	A	
P <sub>D</sub>	Maximum Power Dissipation	210	W	
T <sub>J</sub> T <sub>STG</sub>	Operating Junction and Storage Temperature Range	-55 to +175	° C	
R <sub>θJC</sub>	Thermal Resistance-Junction to Case	0.65	° C/W	
R <sub>θJA</sub>	Thermal Resistance-Junction to Ambient	62		

## Electrical Characteristics(Ta=25° C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Static Characteristics</b>						
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>DS</sub> =250uA	100			V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V			1	uA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> = ± 20V, V <sub>DS</sub> =0V			± 100	nA
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> =250uA	2.0	3.0	4.0	V
R <sub>DS(ON)</sub>	Drain-Source On-state Resistance	V <sub>GS</sub> =10V, I <sub>DS</sub> =40A		6.5		mΩ
g <sub>FS</sub>	Forward Transconductance	V <sub>DS</sub> =50V, I <sub>DS</sub> =40A	100			S

## Electrical Characteristics(Ta=25°C Unless Otherwise Noted)

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
<b>Drain-Source Diode Characteristics</b>						
$V_{SD}$	Diode Forward Voltage	$V_{GS}=0V, I_{SD}=40A$			1.1	V
$T_{rr}$	Reverse Recovery Time	$I_{SD}=40A$		45		ns
$Q_{rr}$	Reverse Recovery Charge	$di/dt=100A/us$		88		nC
<b>Dynamic Characteristics</b>						
$R_G$	Gate Resistance	$V_{GS}=0V, V_{DS}=0V,$ $f=1MHz$		1.8		$\Omega$
$T_{d(on)}$	Turn-on Delay Time	$V_{DS}=50V, R_G=6\Omega,$ $I_{DS}=40A, V_{GS}=10V,$		26		ns
$T_r$	Turn-on Rise Time			45		
$T_{d(off)}$	Turn-off Delay Time			70		
$T_f$	Turn-off Fall Time			51		
$C_{ISS}$	Input Capacitance	$V_{GS}=0V,$ $V_{DS}=25V,$ $f=1.0MHz$		4900		pF
$C_{OSS}$	Output Capacitance			585		
$C_{RSS}$	Reverse Transfer Capacitance			387		
$Q_g$	Total Gate Charge	$V_{DS}=80V, I_D=40A,$ $V_{GS}=10V$		80		nC
$Q_{gs}$	Gate-Source Charge			20		
$Q_{gd}$	Gate-Drain Charge			28		

## Typical electrical and thermal characteristics

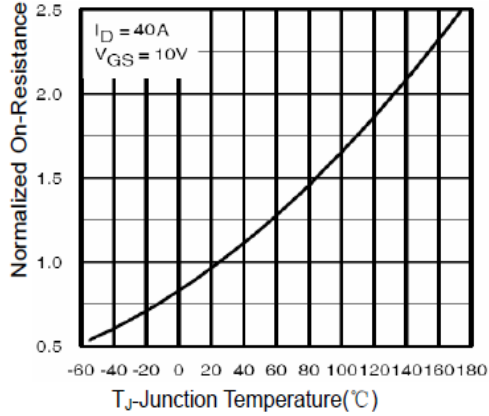


Figure1.  $R_{DS(on)}$ -Junction Temperature

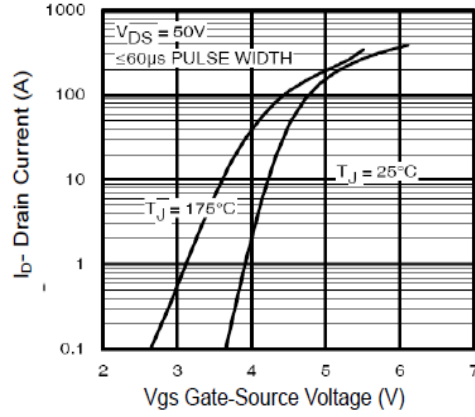


Figure2. Transfer Characteristics

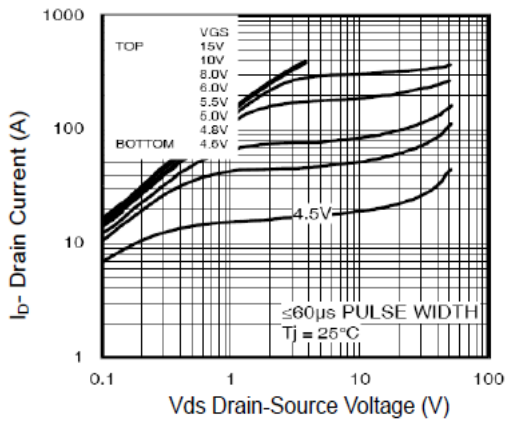


Figure3. Output Characteristics

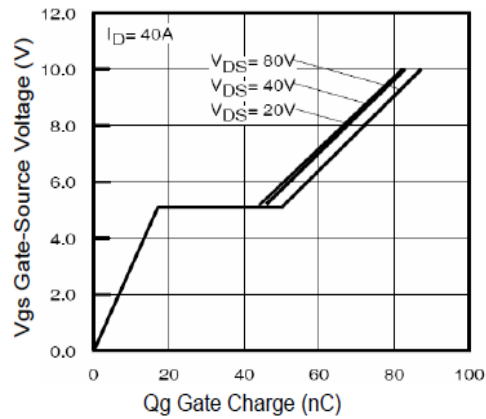


Figure4. Gate Charge

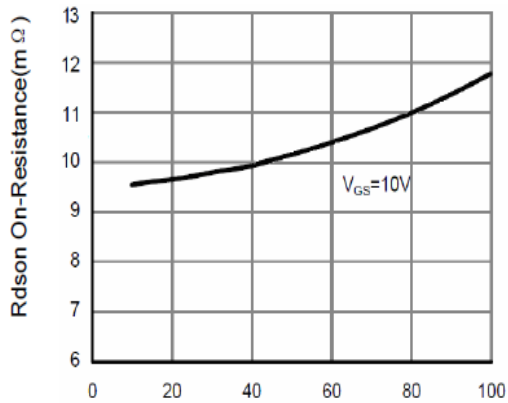


Figure5.  $R_{DS(on)}$ -Drain Current

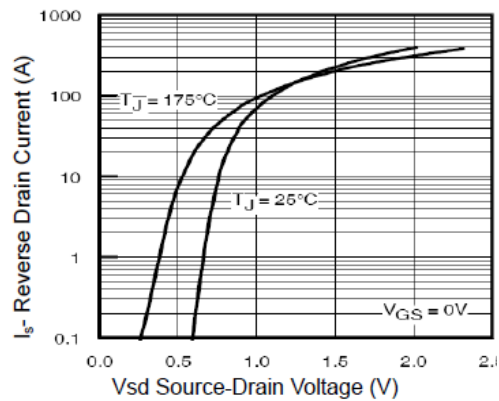


Figure6. Source-Drain Diode Forward

## Typical electrical and thermal characteristics

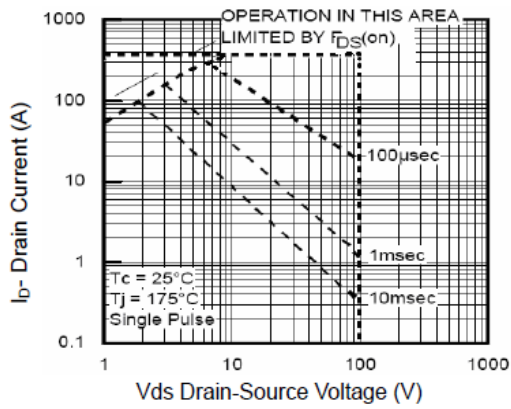


Figure7. Safe Operation Area

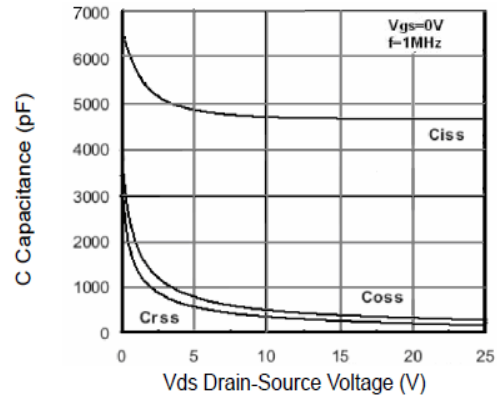


Figure8.  $V_{DS}$  vs. Capacitance

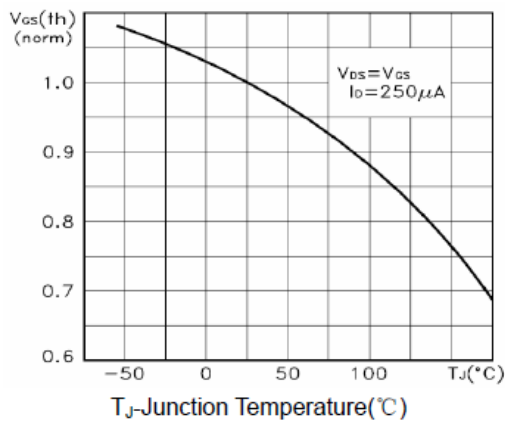


Figure9.  $V_{GS(th)}$  vs. Junction Temperature

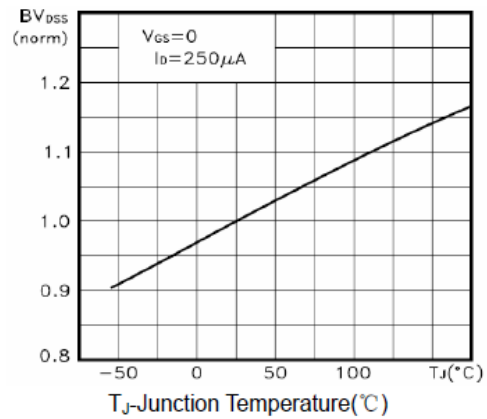


Figure10.  $BV_{DSS}$  vs. Junction Temperature

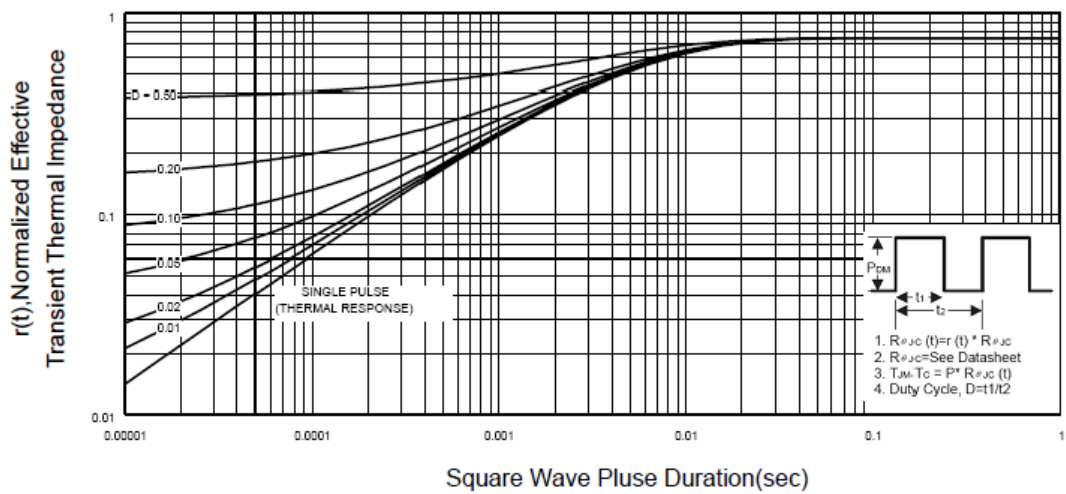
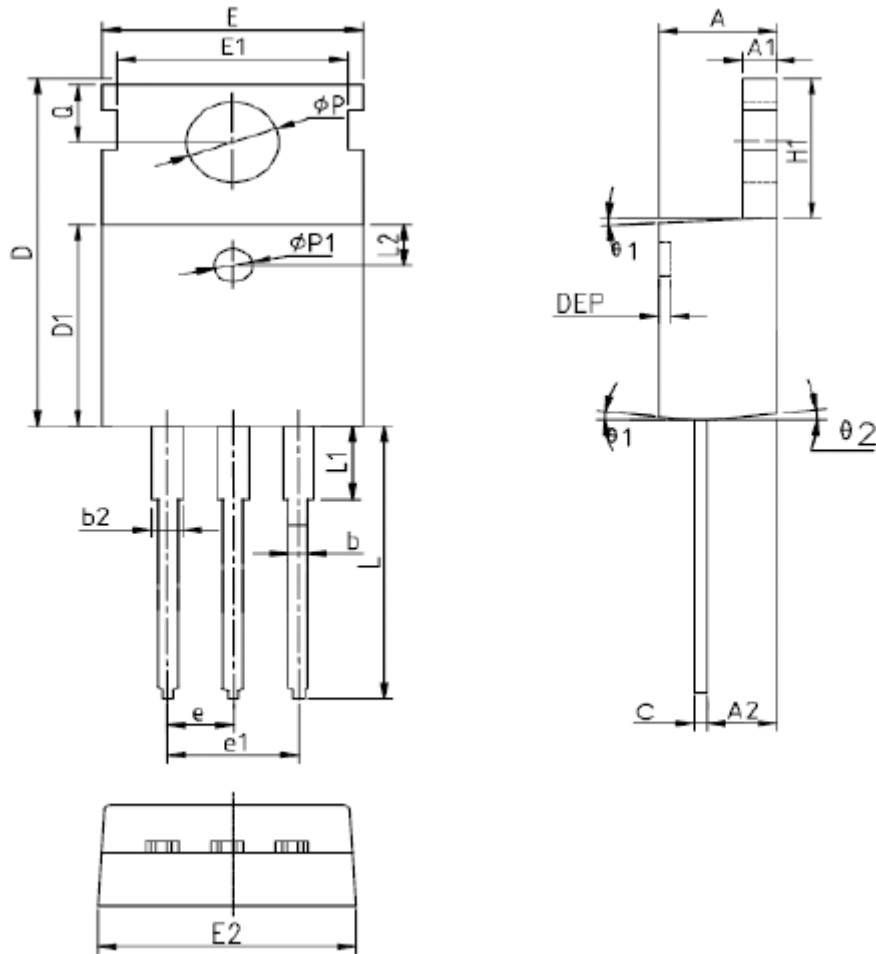


Figure11. Normalized Maximum Transient Thermal Impedance

## TO220-3 Package Outline



SYMBOL	MM			INCH			SYMBOL	MM			INCH		
	MIN	NOM	MAX	MIN	NOM	MAX		MIN	NOM	MAX	MIN	NOM	MAX
A	4.40	4.57	4.70	0.173	0.180	0.185	$\phi p1$	1.40	1.50	1.60	0.055	0.059	0.063
A1	1.27	1.30	1.33	0.050	0.051	0.052	e	2.54BSC			0.1BSC		
A2	2.35	2.40	2.50	0.093	0.094	0.098	e1	5.08BSC			0.2BSC		
b	0.77	-	0.90	0.030	-	0.035	H1	6.40	6.50	6.60	0.252	0.256	0.260
b2	1.23	-	1.36	0.048	-	0.054	L	12.75	-	13.17	0.502	-	0.519
C	0.48	0.50	0.52	0.019	0.020	0.021	L1	-	-	3.95	-	-	0.156
D	15.40	15.60	15.80	0.606	0.614	0.622	L2	2.50REF.			0.098REF.		
D1	9.00	9.10	9.20	0.354	0.358	0.362	$\phi p$	3.57	3.60	3.63	0.141	0.142	0.143
DEP	0.05	0.10	0.20	0.002	0.004	0.008	Q	2.73	2.80	2.87	0.107	0.110	0.113
E	9.70	9.90	10.10	0.382	0.389	0.398	$\theta 1$	5°	7°	9°	5°	7°	9°
E1	-	8.70	-	-	0.343	-	$\theta 2$	1°	3°	5°	1°	3°	5°
E2	9.80	10.00	10.20	0.386	0.394	0.401							